Toshiba BiCD Process Integrated Circuit Silicon Monolithic

# **TB67S149HG**

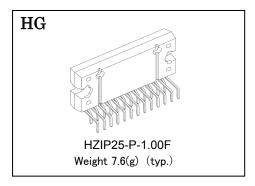
### Clock controlled Unipolar stepping motor driver

The TB67S149 is a Clock controlled PWM chopping type 2 phase unipolar stepping motor driver. Using the BiCD process, the TB67S149HG can be operated with VM voltage of 45V, output voltage of 84V, and output current of 3.0A at max (absolute maximum ratings).

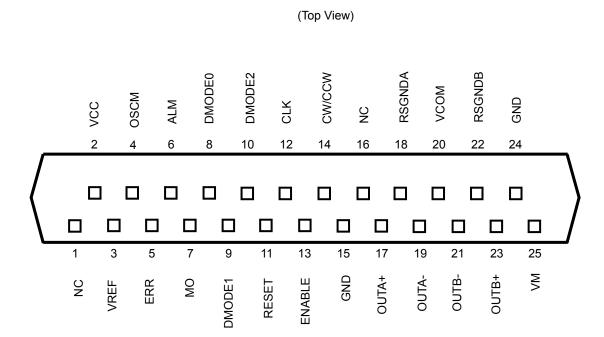
#### **Features**

- •BiCD processed monolithic integrated circuit.
- Capable of operating one unipolar stepping motor.
- •PWM controlled constant current drive.
- •Full, half(a), half(b), quarter, 1/8, 1/16, 1/32 step resolution.
- •Low on resistance(0.25 $\Omega$ (typ.) output MOSFET.
- ·High voltage and current (For specification, please refer to the absolute maximum ratings and operation ranges).
- •Standby (low power) mode function
- Error detect feedback signal output function (Over current/Thermal shutdown).
- Error detect function (Thermal shutdown(TSD), Over current(ISD), and Low voltage(POR).
- •Built-in VCC regulator for internal circuit use.
- Fixed off time can be adjusted by external components.

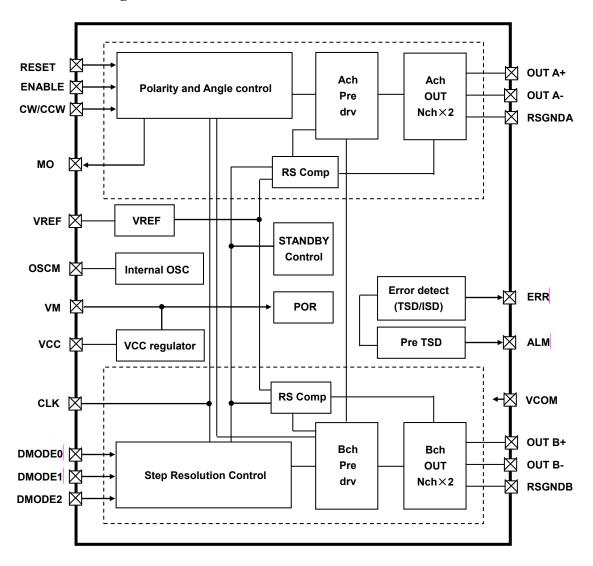
Note) Please be careful about the thermal conditions during use.



## Pin assign (TB67S149HG)



## TB67S149 block diagram



Functional blocks/circuits/constants in the block chart etc. may be omitted or simplified for explanatory purposes.

## **Application Notes**

All the grounding wires of the device must run on the solder mask on the PCB and be externally terminated at only one point. Also, a grounding method should be considered for efficient heat dissipation.

Careful attention should be paid to the layout of the output, VDD(VM) and GND traces, to avoid short circuits across output pins or to the power supply or ground. If such a short circuit occurs, the device may be permanently damaged.

Also, the utmost care should be taken for pattern designing and implementation of the device since it has power supply pins (VM, RSGND, OUT, GND) through which a particularly large current may run. If these pins are wired incorrectly, an operation error may occur or the device may be destroyed.

The logic input pins must also be wired correctly. Otherwise, the device may be damaged owing to a current running through the IC that is larger than the specified current.

## Pin explanations

## **TB67S149HG (HZIP25)**

Pin No.1 to 25

| Pin No.1 to 2 | Pin Name | Function                                  |  |  |  |
|---------------|----------|---|--|--|--|
| 1             | NC       | Non connection                            |  |  |  |
| 2             | VCC      | Internal VCC regulator monitor pin        |  |  |  |
| 3             | VREF     | Constant current threshold set pin        |  |  |  |
| 4             | OSCM     | Fixed off time set pin                    |  |  |  |
| 5             | ERR      | Error detect feedback signal output pin   |  |  |  |
| 6             | ALM      | Thermal alarm output pin                  |  |  |  |
| 7             | MO       | Electrical angle monitor pin              |  |  |  |
| 8             | DMODE0   | Step setting pin 0                        |  |  |  |
| 9             | DMODE1   | Step setting pin 1                        |  |  |  |
| 10            | DMODE2   | Step setting pin 2                        |  |  |  |
| 11            | RESET    | Electrical angle reset pin                |  |  |  |
| 12            | CLK      | External Clock input pin                  |  |  |  |
| 13            | ENABLE   | Motor output ON/OFF pin                   |  |  |  |
| 14            | CW/CCW   | Clock-wise/Counter Clock-wise setting pin |  |  |  |
| 15            | GND      | Ground pin                                |  |  |  |
| 16            | NC       | Non connection                            |  |  |  |
| 17            | OUTA+    | Motor output A+ pin                       |  |  |  |
| 18            | RSGNDA   | Ach current sense ground pin              |  |  |  |
| 19            | OUTA-    | Motor output A-pin                        |  |  |  |
| 20            | VCOM     | Common pin                                |  |  |  |
| 21            | OUTB-    | Motor output B-pin                        |  |  |  |
| 22            | RSGNDB   | Bch current sense ground pin              |  |  |  |
| 23            | OUTB+    | Motor output B+ pin                       |  |  |  |
| 24            | GND      | Ground pin                                |  |  |  |
| 25            | VM       | VM power supply pin                       |  |  |  |

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Please do not run patterns under NC pins.

## **INPUT/OUTPUT Equivalent circuit**

| Pin name                                       | Input / Output  | Equivalent circuit  |
|--|---|---|
| DMODE0 DMODE1 DMODE2 CW/CCW CLK RESET ENABLE   | Logic input (VIH/VIL)  VIH: 2.0V(min) to 5.5V(max)  VIL: 0V(min) to 0.8V(max)   | Logic Input 1kΩ GND MARKET STATE ST |
| ERR<br>ALM<br>MO                               | Logic output (VOH/VOL) $ \mbox{(Pullup resistance : } 10k \mbox{ to } 100k\Omega) $   | Logic<br>Output   |
| VCC<br>VREF                                    | VCC voltage range 4.75V(min) to 5.0V(typ.) to 5.25V(max)  VREF input voltage range 0V to 4.0V (Constant current control)  VCC short(Constant current control : off)   | VCC Δ  VREF Δ  VREF Δ  M  GND Δ   |
| OSCM   | OSCM frequency setup (reference) $0.82 MHz(min) \qquad to \qquad 3.2 MHz(typ.) \qquad to \\ 8.2 MHz(max) \\ (R_OSCM=3.9 k\Omega \ to \ 10 k\Omega \ to \ 39 k\Omega)$ | SCM   |
| OUT A+ OUT A- OUT B+ OUT B- RSGNDA RSGNDB VCOM | VM voltage range 10V(min) to 40V(max)  OUT pin voltage range 10V(min) to 80V(max)   | OUTPUT (+) pin (-) pin (-) pin RSGND  |

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

## **TB67S149 function explanation**

#### **CLK function**

The CLK pin controls the rotation speed of the motor. Each CLK signal will shift the motor's electrical angle per step, due to each up-edge of the CLK signal.

| CLK             | Function   |
|-----------------|--|
| ↑ (Low to High) | Shifts the electrical angle per step.            |
| ↓ (High to Low) | (State of the electrical angle does not change.) |

#### **ENABLE function**

The ENABLE pin controls the ON and OFF of the corresponding output stage. (For accurate operation, please set the ENABLE to 'Low( during VM power-on and power-off sequence.))

| ENABLE | Function                                  |
|--------|---|
| High   | Output stage='ON' (Normal operation mode) |
| Low    | Output stage='OFF' (High impedance mode)  |

### **CW/CCW** function

The CW/CCW pin controls the rotation direction of the motor.

| CW/CCW | Function                 |
|--------|--------------------------|
| High   | Clock-wise (CW)          |
| Low    | Counter Clock-wise (CCW) |

When set to 'CW', the Ach current phase leads the Bch current phase by  $90^\circ$  . When set to 'CCW', the Bch current phase leads the Ach current phase by  $90^\circ$  .

## **RESET function**

The RESET pin controls the resetting of the internal electrical angle. (For accurate operation, please set the RESET pin to 'High' during VM power-on. Switch the RESET to 'Low', once the VM voltage has reached the operation range.)

| RESET | Function   |
|-------|--|
| High  | Sets the electrical angle to the initial position. |
| Low   | Normal operation                                   |

The current setting for each channel (while RESET is applied) is shown in the table below. MO pin level will show 'Low' level at this time.

| Step resolution setting | Ach current | Bch current | Electrical angle |
|-------------------------|-------------|-------------|------------------|
| Full step               | 100%        | 100%        | 45°              |
| Half step (a)           | 100%        | 100%        | 45°              |
| Quarter step            | 71%         | 71%         | 45°              |
| Half step (b)           | 71%         | 71%         | 45°              |
| 1/8 step                | 71%         | 71%         | 45°              |
| 1/16 step               | 71%         | 71%         | 45°              |
| 1/32 step               | 71%         | 71%         | 45°              |

## **DMODE** (Step resolution setting) function

The DMODE pin controls the Standby mode and the step resolution setting.

| DMODE0 | DMODE1 | DMODE2 | Function   |
|--------|--------|--------|--|
| Low    | Low    | Low    | Standby mode (The internal oscillator is disabled and the output stage is set to 'OFF' status. The internal status is Full step, Torque100% (*)) |
| Low    | Low    | High   | Full step  |
| Low    | High   | Low    | Half step(a)   |
| Low    | High   | High   | Quarter step   |
| High   | Low    | Low    | Half step(b)   |
| High   | Low    | High   | 1/8 step   |
| High   | High   | Low    | 1/16 step  |
| High   | High   | High   | 1/32 step  |

<sup>(\*) [</sup>Full step, Torque 100%] written above shows the initial status of the logic. During Standby mode, the internal oscillator and output stage is set to OFF, therefore does not mean that the device will operate at [Full step, Torque 100%].

## Standby mode function

Setting all of the DMODE pins(DMODE0,DMODE1,DMODE2) to Low will set the device to Standby mode. During Standby mode, the internal bias current is cut so that the device be set to low power mode. Also, setting the device to Standby mode will release the error detection such as TSD and ISD.

| Standby mode                      | Function                             |
|-----------------------------------|--------------------------------------|
| ON (DMODE0,1,2=L,L,L)             | Standby mode : ON (Low power mode)   |
| OFF (other than DMODE0,1,2=L,L,L) | Standby mode: OFF (Normal operation) |

After the device detects an error such as TSD or ISD, setting the device to Standby mode to OFF and then ON again will release the error detect latch signal. (Reasserting the VM power will also release the error detect latch signal.)

Note) After setting the Standby mode: OFF, the internal circuit will restart from low power mode. During the startup period ( $10\mu s$  after setting the Standby mode: OFF), please do not send any control signals. (If the signal is sent to the device during the startup period, the device may not be able to accept the signal correctly.)

## Step resolution and current ratio

| 01                | Step resolution |          |          |         |                  |   |      |             | T    | l lmit |
|-------------------|-----------------|----------|----------|---------|------------------|---|------|-------------|------|--------|
| Characteristics - | Full            | Half (a) | Half (b) | Quarter | Quarter 1/8 1/16 |   | 1/32 | Step        | Тур. | Unit   |
|                   | 0               | 0        | 0        | 0       | 0                | 0 | 0    | θ 32        | 100  |        |
| -                 |                 |          |          |         | -                | _ | 0    | θ 31        | 100  |        |
|                   |                 |          |          |         |                  | 0 | 0    | θ 30        | 100  |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 29        | 99   |        |
|                   |                 |          |          | -       | 0                | 0 | 0    | θ 28        | 98   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 27        | 97   |        |
|                   |                 |          |          |         | -                | 0 | 0    | θ 26        | 96   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 25        | 94   |        |
|                   |                 | -        | -        | (*2)    | 0                | 0 | 0    | θ 24        | 92   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 23        | 90   |        |
|                   |                 |          |          |         | -                | 0 | 0    | θ 22        | 88   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 21        | 86   | 1      |
|                   |                 |          |          | -       | 0                | 0 | 0    | θ 20        | 83   |        |
|                   | _               |          |          |         |                  | _ | 0    | <i>θ</i> 19 | 80   |        |
| Current<br>Ratio  |                 |          |          |         | -                | 0 | 0    | <i>θ</i> 18 | 77   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ 17        | 74   |        |
|                   |                 | (*1)     | 0        | 0       | 0                | 0 | 0    | <i>θ</i> 16 | 71   | %      |
|                   |                 | _        | _        | -       | -                | - | 0    | θ 15        | 67   |        |
|                   |                 |          |          |         |                  | 0 | 0    | θ 14        | 63   |        |
|                   |                 |          |          |         |                  | - | 0    | θ 13        | 60   |        |
|                   |                 |          |          |         | 0                | 0 | 0    | θ 12        | 56   |        |
|                   |                 |          |          |         | -                | - | 0    | θ11         | 52   |        |
|                   |                 |          |          |         |                  | 0 | 0    | θ 10        | 47   |        |
|                   |                 |          |          |         |                  | - | 0    | θ9          | 43   | 1      |
|                   |                 |          |          | 0       | 0                | 0 | 0    | θ8          | 38   |        |
|                   |                 |          |          |         |                  | - | 0    | θ7          | 34   | -      |
|                   |                 |          |          |         | -                | 0 | 0    | θ6          | 29   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ5          | 25   |        |
|                   |                 |          |          | _       | 0                | 0 | 0    | θ4          | 20   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ3          | 15   |        |
|                   |                 |          |          |         |                  | 0 | 0    | θ2          | 10   |        |
|                   |                 |          |          |         |                  | _ | 0    | θ1          | 5    |        |
|                   |                 | 0        | 0        | 0       | 0                | 0 | 0    | θ0          | 0    |        |

<sup>(\*1)</sup> At Half (a) setting, the current ratio will be 100%.

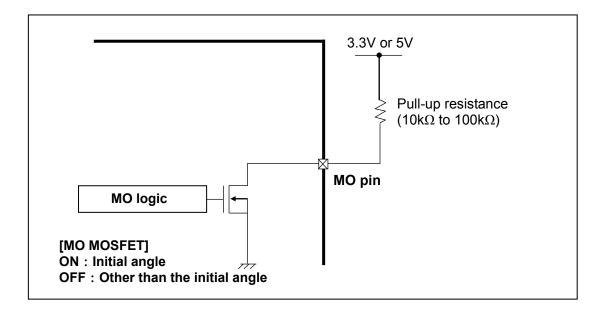
<sup>(\*2)</sup> At Quarter setting, the current ratio will be 100%.

## Monitor pin functions (MO feedback)

| МО       | Function                         |
|----------|----------------------------------|
| Hi-Z (*) | - (Other than the initial angle) |
| Low      | Initial electrical angle         |

(\*) The MO pin is an open drain logic output. To use the function correctly, please make sure the MO pin is connected to 3.3V or 5.0V with a pull-up resistance. If the internal electrical angle is at the initial angle, the pin level will be Low (internal MOSFET: ON). If the internal electrical angle is not at the initial angle, the pin level will be Hi-Z (internal MOSFET:OFF) (it will show High level when pulled up correctly). Please refer to the 'RESET function' for the initial angle.

MO pin should be left open; when not using the MO feedback function.



Equivalent circuit(s) may be omitted for explanatory purpose.

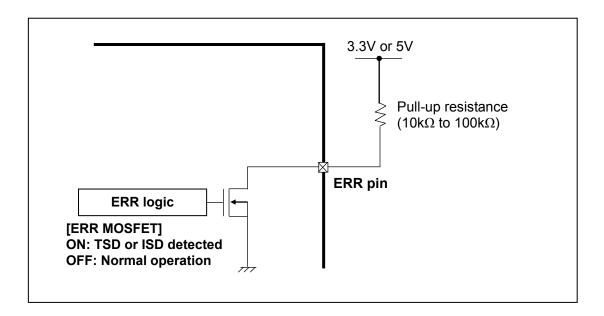
## Monitor pin functions (ERR feedback)

| ERR      | Function                    |
|----------|-----------------------------|
| Hi-Z (*) | Normal operation            |
| Low      | Error detected (TSD or ISD) |

(\*) The ERR pin is an open drain logic output. To use the function correctly, please make sure the ERR pin is connected to 3.3V or 5.0V with a pull-up resistance. During normal operation, the pin level will be Hi-Z (internal MOSFET:OFF) (it will show High level when pulled up), and once an error (TSD or ISD) has been detected, the pin level will be Low (internal MOSFET: ON).

Reasserting the VM power supply or using the STBY function, the ERR pin will return to the initial status (internal MOSFET: OFF).

ERR pin should be left open; when not using the ERR feedback function.



Equivalent circuit(s) may be omitted for explanatory purpose.

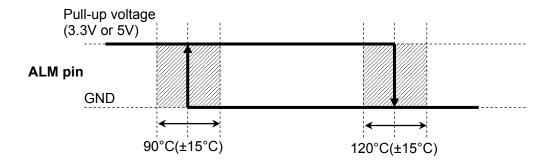
### Monitor pin functions (Thermal ALM feedback)

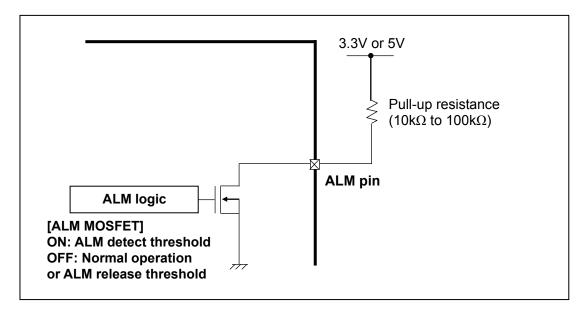
| ALM      | Function               |
|----------|------------------------|
| Hi-Z (*) | Normal operation       |
| Low      | Thermal Alarm detected |

(\*) The ALM pin is an open drain logic output. To use the function correctly, please make sure the ALM pin is connected to 3.3V or 5.0V with a pull-up resistance. During normal operation, the pin level will be Hi-Z (internal MOSFET:OFF) (it will show High level when pulled up), and once the device detects a temperature rise, the pin level will be Low (internal MOSFET: ON).

The ALM is an auto recovery type output. Once the device reaches the ALM detect threshold( $120^{\circ}C \pm 15^{\circ}C$ ), the pin level will show Low (internal MOSFET:ON), and after the device reaches the ALM release threshold ('detect threshold'- $30^{\circ}C$ ), the pin level will show Hi-Z (internal MOSFET:OFF) (it will show High level when pulled up)

ALM pin should be left open; when not using the thermal ALM feedback function.





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Timing charts may be simplified for explanatory purpose.

Equivalent circuit(s) may be omitted for explanatory purpose.

### **TB67S149** setup

## **Constant-current threshold setting**

The constant-current threshold can be set by VREF voltage.

 $IOUT(max)=VREF \times 3/4$ 

Example: Current setting 100%, VREF=2.0V: The constant current thredhold(peak current) will be as shown below.

 $IOUT = 2.0 \times 3/4 = 1.5A$ 

To set the constant-current function 'off', connect the VCC and VREF pin directly (do not use any external power supply). Also, please be careful about the thermal conditions during use.

## Fixed off time setting

To set the fixed off time for constant-current PWM control, please connect a pull-down resistance to the OSCM pin. The relation between the pull-down resistance(ROSCM) and fixed off time is as shown below.

(For reference)

| Pull-down resistance | (ROSCM)          | Fixed off time (toff) |
|----------------------|------------------|-----------------------|
|                      | 3.9kΩ            | 4.1μs                 |
|                      | $4.7$ k $\Omega$ | 4.9μs                 |
|                      | $5.6$ k $\Omega$ | 5.8μs                 |
|                      | 6.8kΩ            | 7.0µs                 |
|                      | 8.2kΩ            | 8.3µs                 |
|                      | 10kΩ             | 10μs                  |
|                      | 15kΩ             | 15µs                  |
|                      | 18kΩ             | 18μs                  |
|                      | <b>22</b> kΩ     | 21μs                  |
|                      | 27kΩ             | 26μs                  |
|                      | 39kΩ             | 37μs                  |

Note) The value shown in the graph above does not include any dispersion of the device / external components.

## Absolute maximum ratings (Ta=25°C)

| Characteristics                                   | Symbol      | Rating     | Unit |
|---|-------------|------------|------|
| Motor power supply                                | VM(max)     | 45         | V    |
| VM-VCOM voltage differential                      | VDIFF(max)  | 45         | V    |
| Motor output voltage                              | VOUT(max)   | 84         | V    |
| Motor output current (per channel)                | IOUT(max)   | 3.0        | А    |
| Internal logic power supply                       | VCC(max)    | 6.0        | V    |
| Logic input veltage                               | VIN(H)(max) | 6.0        | V    |
| Logic input voltage                               | VIN(L)(min) |            |      |
| VREF input voltage                                | VREF(max)   | 6.0        | V    |
| Open drain output pin (ERR,ALM,MO) voltage        | VOD(max)    | 6.0        | V    |
| Open drain output pin (ERR,ALM,MO) inflow current | IOD(max)    | 20         | mA   |
| Power dissipation (HZIP25; device alone)          | PD          | 3.2        | W    |
| Operating temperature                             | Topr        | -20 to 85  | °C   |
| Storage temperature                               | Tstr        | -55 to 150 | °C   |
| Junction temperature                              | Tj(max)     | 150        | °C   |

### Caution) Absolute maximum ratings

The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings.

Exceeding the rating (s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.

The value of even one parameter of the absolute maximum ratings should not be exceeded under any circumstances. The device does not have overvoltage detection circuit. Therefore, the device is damaged if a voltage exceeding its rated maximum is applied.

All voltage ratings, including supply voltages, must always be followed. The other notes and considerations described later should also be referred to.

## **Operation ranges**

| Characteristics                     | Symbol       | Test condition         | Min  | Тур. | Max  | Unit |
|-------------------------------------|--------------|------------------------|------|------|------|------|
| Motor power supply                  | VM           | -                      | 10   | -    | 40   | V    |
| Motor output voltage                | VOUT         | -                      | 10   | -    | 80   | V    |
| Motor output current (per channel)  | IOUT         | Ta=25°C                | -    | 1.5  | 3.0  | Α    |
| Internal logic power supply         | VCC          | -                      | 4.75 | 5.0  | 5.25 | V    |
| Landa tanantan Mana                 | VIN(H)       | Logic input high level | 2.0  | -    | 5.5  | V    |
| Logic input voltage                 | VIN(L)       | Logic input low level  | 0    | -    | 0.8  | V    |
| VREF input voltage range            | VREF(range)  | -                      | GND  | -    | 5.5  | V    |
| Open drain pin voltage range        | VOD(range)   | ERR,ALM,MO pin         | 3.0  | -    | 5.5  | V    |
| Open drain pin inflow current range | IOD(range)   | ERR,ALM,MO pin         | -    | -    | 10   | mA   |
| Internal oscillator frequency range | fOSCM(range) | -                      | 820  | 3200 | 8200 | kHz  |
| Fixed off time range                | tOFF(range)  | -                      | 5    | 10   | 40   | μS   |

Note) Maximum current for actual usage may be limited by the operating circumstances such as operating conditions (exciting mode, operating time, and so on), ambient temperature, and heat conditions (board condition and so on).

## Electrical Specifications 1 (Ta = 25°C, VM = 24 V, unless specified otherwise)

| Characteristics                    |                     | Symbol       | Test condition  | Min  | Тур. | Max  | Unit |
|------------------------------------|---------------------|--------------|---|------|------|------|------|
| Logio input voltago                |                     | VIH          | Logic input pin High level (*)                          | 2.0  | -    | 5.5  | V    |
| Logic input voltage                | Logic input voltage |              | Logic input pin Low level (*)                           | GND  | -    | 0.8  | ٧    |
| Logic input hysteresis voltage     |                     | VIN(HYS)     | Logic input pin (*)                                     | 100  | -    | 300  | mV   |
| Logic input current                | High                | IIN(H)       | Logic input voltage High level (VIN=VIH)                | -    | 33   | 55   | μА   |
| Logic input current                | Low                 | IIN(L)       | Logic input voltage Low level (VIN=VIL)                 | -    | -    | 1    | μΑ   |
|                                    |                     | IM1          | Output pins=open, Standby mode                          | -    | -    | 1.0  | mA   |
| Power consumption                  |                     | IM2          | Output pins=open, Normal operation Full step resolution | -    | 3.0  | 5.0  | mA   |
| Open drain output pin voltage      |                     | VOD(L)       | IOD=10mA  | 0    | -    | 0.5  | V    |
| Motor current channel differential |                     | ⊿IOUT1       | Current differential between channels (IOUT=1.0A)       | -5   | 0    | +5   | %    |
| Motor current setting accuracy     |                     | ⊿IOUT2       | IOUT=1.0A   | -6   | 0    | +6   | %    |
| Source-drain diode forward voltage |                     | VFN          | IOUT=2.0A   | 0.85 | -    | 1.45 | V    |
| Motor output off leak current      | lleak               |              | VOUT=80V, Output MOSFET:OFF                             | -    | -    | 1    | μА   |
| Motor output ON-resis              | stance              | RON<br>(D-S) | IOUT=2.0A   | -    | 0.25 | 0.35 | Ω    |

<sup>(\*)</sup> VIN (H) is defined as the VIN voltage that causes the outputs (OUTA, OUTB) to change when a pin under test is gradually raised from 0 V. VIN (L) is defined as the VIN voltage that causes the outputs (OUTA, OUTB) to change when the pin is then gradually lowered. The difference between VIN (L) and VIN (H) is defined as the VIN(HYS).

## Electrical Specifications 2 (Ta =25°C, VM = 24 V, unless specified otherwise)

| Characteristics                           | Symbol | Test condition  | Min  | Тур. | Max  | Unit |
|---|--------|-----------------|------|------|------|------|
| VCC regulator voltage                     | VCC    | ICC=5.0mA       | 4.75 | 5    | 5.25 | ٧    |
| VCC regulator current                     | ICC    | 4.75V≤VCC≤5.25V | -    | 2.5  | 5.0  | mA   |
| VREF input current                        | IREF   | VREF=2.0V       | -    | 0    | 1.0  | μΑ   |
| Thermal shutdown(TSD) threshold (*)       | TjTSD  | -               | 140  | 155  | 170  | °C   |
| VCC recovery voltage                      | VCCR   | -               | 3.5  | 4.0  | 4.5  | V    |
| VM recovery voltage                       | VMR    | -               | 7.0  | 8.0  | 9.0  | V    |
| Over-current detection(ISD) threshold (*) | ISD    | -               | 3.1  | 4.0  | 5.0  | Α    |

#### (\*) About Thermal shutdown (TSD)

When the junction temperature of the device reached the TSD threshold, the TSD circuit is triggered; the internal reset circuit then turns off the output transistors. Noise rejection blanking time is built-in to avoid misdetection. Once the TSD circuit is triggered; the detect latch signal can be cleared by reasserting the VM power source, or setting the device to standby mode. The TSD circuit is a backup function to detect a thermal error, therefore is not recommended to be used aggressively.

#### (\*) About Over-current detection (ISD)

When the output current reaches the threshold, the ISD circuit is triggered; the internal reset circuit then turns off the output transistors. Once the ISD circuit is triggered, the detect latch signal can be cleared by reasserting the VM power source, or setting the device to standby mode. For fail-safe, please insert a fuse to avoid secondary trouble.

#### Back-EMF

While a motor is rotating, there is a timing at which power is fed back to the power supply. At that timing, the motor current recirculates back to the power supply due to the effect of the motor back-EMF.

If the power supply does not have enough sink capability, the power supply and output pins of the device might rise above the rated voltages. The magnitude of the motor back-EMF varies with usage conditions and motor characteristics. It must be fully verified that there is no risk that the device or other components will be damaged or fail due to the motor back-EMF.

### Cautions on Overcurrent Shutdown (ISD) and Thermal Shutdown (TSD)

The ISD and TSD circuits are only intended to provide temporary protection against irregular conditions such as an output short-circuit; they do not necessarily guarantee the complete IC safety.

If the device is used beyond the specified operating ranges, these circuits may not operate properly: then the device may be damaged due to an output short-circuit.

The ISD circuit is only intended to provide a temporary protection against an output short-circuit. If such condition persists for a long time, the device may be damaged due to overstress. Overcurrent conditions must be removed immediately by external hardware.

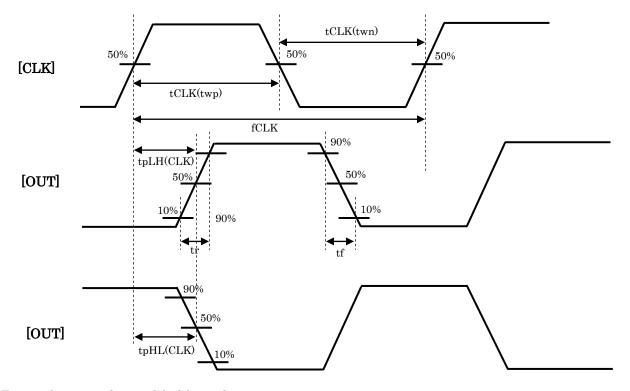
### **IC Mounting**

Do not insert devices incorrectly or in the wrong orientation. Otherwise, it may cause breakdown, damage and/or deterioration of the device.

AC Electrical Specification (Ta =25°C, VM = 24 V, unless specified otherwise)

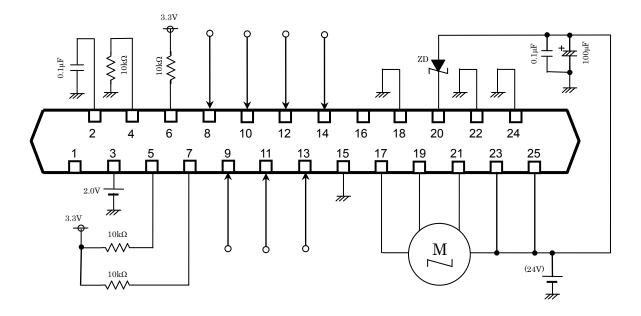
| 0          | T   | B 41   | -  |                    | 11.31  |
|------------|---|--|--|--------------------|--|
| Symbol     | l est condition   | Min  | Typ.   | Max                | Unit   |
| fCLK       | fOSCM=3200kHz   | -  | -  | 100                | kHz  |
| tCLK(twp)  | -   | 50   | -  | 1                  | ns   |
| tCLK(twn)  | -   | 50   | -  | -                  | ns   |
| tr         | -   | 50   | 100  | 150                | ns   |
| tf         | -   | 50   | 100  | 150                | ns   |
| tpLH(CLK)  | CLK→OUT   | 200  | 700  | 1200               | ns   |
| tpHL(CLK)  | CLK→OUT   | 200  | 700  | 1200               | ns   |
| AtBLK      | Analog tblank   | 250  | 400  | 550                | ns   |
| fOSCM      | ROSC=10kΩ   | 2720   | 3200   | 3680               | kHz  |
| fOSCS      | -   | 5120   | 6400   | 7680               | kHz  |
| tOFF       | fOSCM=3.2MHz  | 8.5  | 10   | 11.5               | μS   |
| tISD(mask) | fOSCS(=6.4MHz)*8clk   | 1.0  | 1.25   | 1.5                | μS   |
|            |   |  |  |                    |  |
| tTSD(mask) | fOSCS(=6.4MHz)*32clk  | 4.0  | 5.0  | 6.0                | μS   |
|            |   |  |  |                    |  |
| tALM(mask) | fOSCS(=6.4MHz)*16clk  | 2.0  | 2.5  | 3.0                | μS   |
|            |   |  |  |                    |  |
|            | tCLK(twp) tCLK(twn) tr tf tpLH(CLK) tpHL(CLK) AtBLK fOSCM fOSCS tOFF tISD(mask) | fCLK fOSCM=3200kHz  tCLK(twp) -  tCLK(twn) -  tr -  tf -  tpLH(CLK) CLK→OUT  tpHL(CLK) CLK→OUT  AtBLK Analog tblank  fOSCM ROSC=10kΩ  fOSCS -  tOFF fOSCM=3.2MHz  tISD(mask) fOSCS(=6.4MHz)*8clk | fCLK       fOSCM=3200kHz       -         tCLK(twp)       -       50         tr       -       50         tf       -       50         tpLH(CLK)       CLK→OUT       200         tpHL(CLK)       CLK→OUT       200         AtBLK       Analog tblank       250         fOSCM       ROSC=10kΩ       2720         fOSCS       -       5120         tOFF       fOSCM=3.2MHz       8.5         tISD(mask)       fOSCS(=6.4MHz)*8clk       1.0         tTSD(mask)       fOSCS(=6.4MHz)*32clk       4.0 | fCLK fOSCM=3200kHz | fCLK       fOSCM=3200kHz       -       -       100         tCLK(twp)       -       50       -       -         tCLK(twn)       -       50       -       -         tr       -       50       100       150         tf       -       50       100       150         tpLH(CLK)       CLK→OUT       200       700       1200         tpHL(CLK)       CLK→OUT       200       700       1200         AtBLK       Analog tblank       250       400       550         fOSCM       ROSC=10kΩ       2720       3200       3680         fOSCS       -       5120       6400       7680         tOFF       fOSCM=3.2MHz       8.5       10       11.5         tISD(mask)       fOSCS(=6.4MHz)*8clk       1.0       1.25       1.5         tTSD(mask)       fOSCS(=6.4MHz)*32clk       4.0       5.0       6.0 |

## AC specification timing chart



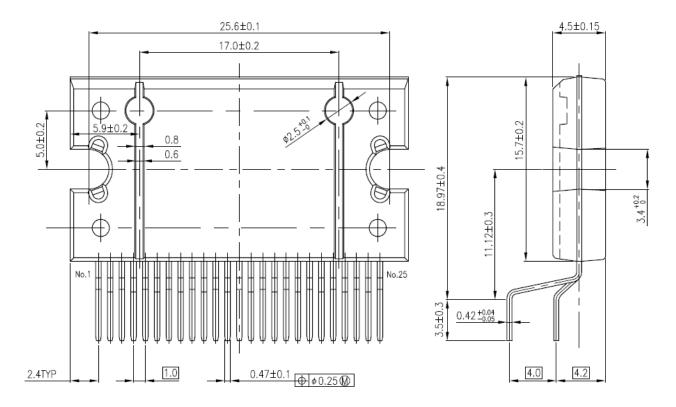
Timing charts may be simplified for explanatory purpose.

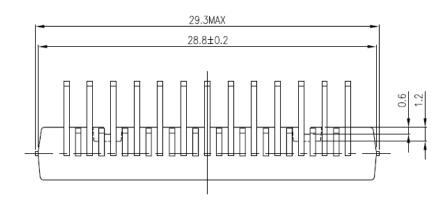
## Application circuit example



The application circuit above is an example; therefore, mass-production design is not guaranteed.

## Package dimensions (Unit:mm): HZIP25-P-1.00F





Weight: 7.6(g)(typ.)

Note) The tightening torque for the mounting bracket should be controlled between  $0.4N \cdot m$  to  $0.6N \cdot m$ .

#### **Notes on Contents**

#### **Block Diagrams**

Some of the functional blocks, circuits, or constants in the block diagram may be omitted or simplified for explanatory purposes.

### **Equivalent Circuits**

The equivalent circuit diagrams may be simplified or some parts of them may be omitted for explanatory purposes.

#### **Timing Charts**

Timing charts may be simplified for explanatory purposes.

#### **Application Circuits**

The application circuits shown in this document are provided for reference purposes only. Thorough evaluation is required, especially at the mass-production design stage.

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#### **Test Circuits**

Components in the test circuits are used only to obtain and confirm the device characteristics. These components and circuits are not guaranteed to prevent malfunction or failure from occurring in the application equipment.

### IC Usage Considerations

### Notes on handling of ICs

- (1) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. Exceeding the rating(s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.
- (2) Use an appropriate power supply fuse to ensure that a large current does not continuously flow in the case of overcurrent and/or IC failure. The IC will fully break down when used under conditions that exceed its absolute maximum ratings, when the wiring is routed improperly or when an abnormal pulse noise occurs from the wiring or load, causing a large current to continuously flow and the breakdown can lead to smoke or ignition. To minimize the effects of the flow of a large current in the case of breakdown, appropriate settings, such as fuse capacity, fusing time and insertion circuit location, are required.
- (3) If your design includes an inductive load such as a motor coil, incorporate a protection circuit into the design to prevent device malfunction or breakdown caused by the current resulting from the inrush current at power ON or the negative current resulting from the back electromotive force at power OFF. IC breakdown may cause injury, smoke or ignition. Use a stable power supply with ICs with built-in protection functions. If the power supply is unstable, the protection function may not operate, causing IC breakdown. IC breakdown may cause injury, smoke or ignition.
- (4) Do not insert devices in the wrong orientation or incorrectly. Make sure that the positive and negative terminals of power supplies are connected properly.
- Otherwise, the current or power consumption may exceed the absolute maximum rating, and exceeding the rating(s) may cause device breakdown, damage or deterioration, and may result in injury by explosion or combustion.
- In addition, do not use any device inserted in the wrong orientation or incorrectly to which current is applied even just once.
- (5) Carefully select external components (such as inputs and negative feedback capacitors) and load components (such as speakers), for example, power amp and regulator.

If there is a large amount of leakage current such as from input or negative feedback condenser, the IC output DC voltage will increase. If this output voltage is connected to a speaker with low input withstand voltage, overcurrent or IC failure may cause smoke or ignition. (The overcurrent may cause smoke or ignition from the IC itself.) In particular, please pay attention when using a Bridge Tied Load (BTL) connection-type IC that inputs output DC voltage to a speaker directly.

## Points to remember on handling of ICs

#### **Overcurrent detection Circuit**

Overcurrent detection circuits (referred to as current limiter circuits) do not necessarily protect ICs under all circumstances. If the overcurrent detection circuits operate against the overcurrent, clear the overcurrent status immediately.

Depending on the method of use and usage conditions, exceeding absolute maximum ratings may cause the overcurrent detection circuit to operate improperly or IC breakdown may occur before operation. In addition, depending on the method of use and usage conditions, if overcurrent continues to flow for a long time after operation, the IC may generate heat resulting in breakdown.

#### **Thermal Shutdown Circuit**

Thermal shutdown circuits do not necessarily protect ICs under all circumstances. If the thermal shutdown circuits operate against the over-temperature, clear the heat generation status immediately.

Depending on the method of use and usage conditions, exceeding absolute maximum ratings may cause the thermal shutdown circuit to operate improperly or IC breakdown to occur before operation.

#### **Heat Radiation Design**

When using an IC with large current flow such as power amp, regulator or driver, design the device so that heat is appropriately radiated, in order not to exceed the specified junction temperature (TJ) at any time or under any condition. These ICs generate heat even during normal use. An inadequate IC heat radiation design can lead to decrease in IC life, deterioration of IC characteristics or IC breakdown. In addition, when designing the device, take into consideration the effect of IC heat radiation with peripheral components.

#### **Back-EMF**

When a motor rotates in the reverse direction, stops or slows abruptly, current flows back to the motor's power supply owing to the effect of back-EMF. If the current sink capability of the power supply is small, the device's motor power supply and output pins might be exposed to conditions beyond the absolute maximum ratings. To avoid this problem, take the effect of back-EMF into consideration in system design.

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